

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yutaka Ikku</td> <td>09/18/2007</td> </tr> <tr> <td>Tatsuya Asahata</td> <td>09/18/2007</td> </tr> <tr> <td>Hidekazu Suzuki</td> <td>09/12/2007</td> </tr> </tbody> </table>		Name	Execution Date	Yutaka Ikku	09/18/2007	Tatsuya Asahata	09/18/2007	Hidekazu Suzuki	09/12/2007
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Yutaka Ikku	09/18/2007								
Tatsuya Asahata	09/18/2007								
Hidekazu Suzuki	09/12/2007								
RECEIVING PARTY DATA									
Name:	SII Nano Technology Inc.								
Street Address:	8, Nakase 1-chome, Mihama-ku								
City:	Chiba-shi, Chiba								
State/Country:	JAPAN								
Postal Code:	261-8507								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11824994</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11824994				
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Application Number:	11824994								
CORRESPONDENCE DATA									
Fax Number:	(312)321-4299								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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ATTORNEY DOCKET NUMBER:	11106/88								
NAME OF SUBMITTER:	Tadashi Horie								

Total Attachments: 2
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PATENT
REEL: 020068 FRAME: 0059

CH \$40.00 11824994

ASSIGNMENT

WHEREAS, Yutaka IKKU, Tatsuya ASAHATA and Hidekazu SUZUKI, hereinafter called the "Assignors", have made the invention described in the United States patent application entitled METHOD AND APPARATUS OF MEASURING THIN FILM SAMPLE AND METHOD AND APPARATUS OF FABRICATING THIN FILM SAMPLE, for a full description of which reference is here made to an application for Letters Patent of the United States filed on July 2, 2007 and assigned Application Serial No. 11/824,994;

WHEREAS, SII NanoTechnology Inc., a corporation organized and existing under the laws of Japan, having a place of business at 8, Nakase 1-chome, Mihama-ku, Chiba-shi, Chiba, Japan 261-8507, hereinafter called the "Assignee", desires to acquire the entire right, title and interest in and to the invention and the patent application identified above, and all patents which may be obtained for said invention, as set forth below;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other valuable and legally sufficient consideration, the receipt of which by the Assignors from the Assignee is hereby acknowledged, the Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer to the Assignee, the entire right, title and interest for the United States in and to the invention and the patent application identified above, and any patents that may issue for said invention in the United States; together with the entire right, title and interest in and to said invention and all patent applications and patents therefor in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; together with the entire right, title and interest in and to all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; to have and to hold for the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignors hereby covenant and agree, for both the Assignors and the Assignors' legal representatives, that the Assignors will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in

vesting in the Assignee like exclusive title in and to all such other patent applications and patents; and in the prosecution of any interference which may arise involving said invention, or any such patent application or patent; and that the Assignors will execute and deliver to the Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

The Commissioner of Patents and Trademarks is hereby authorized and requested to issue patents to the Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the Assignors have executed this agreement.

DATE: 07.09.18 一宮 隆
Yutaka IKKU

WITNESSED: Masaki I.L.

DATE: _____

DATE: _____

DATE: 07.09.18 Tatsuya Asahata
Tatsuya ASAHATA

WITNESSED: Masaki I.L.

DATE: _____

DATE: _____

DATE: 07.09.12 Hidekazu Suzuki
Hidekazu SUZUKI

WITNESSED: Masaki I.L.

DATE: _____

DATE: _____